## Vishay High Power Products

## HEXFRED<sup>®</sup> Ultrafast Soft Recovery Diode, 8 A



- Ultrafast recovery
- Ultrasoft recovery
- Very low I<sub>RRM</sub>
- Very low Q<sub>rr</sub>
- Specified at operating conditions
- Lead (Pb)-free
- Designed and qualified for industrial level

#### BENEFITS

- Reduced RFI and EMI
- Reduced power loss in diode and switching transistor
- Higher frequency operation
- Reduced snubbing
- · Reduced parts count

#### DESCRIPTION

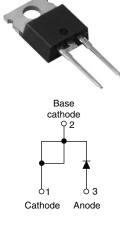
HFA08TB120 is a state of the art ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 1200 V and 8 A continuous current, the HFA08TB120 is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I<sub>RBM</sub>) and does not exhibit any tendency to "snap-off" during the tb portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED HFA08TB120 is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Cathode to anode voltage	V <sub>R</sub>		1200	V	
Maximum continuous forward current	١ <sub>F</sub>	T <sub>C</sub> = 100 °C	8		
Single pulse forward current	I <sub>FSM</sub>		130	А	
Maximum repetitive forward current	I <sub>FRM</sub>		32		
Maximum neuror discipation	PD	T <sub>C</sub> = 25 °C	73.5	w	
Maximum power dissipation		T <sub>C</sub> = 100 °C	29	- vv	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		- 55 to + 150	°C	

\* Pb containing terminations are not RoHS compliant, exemptions may apply







TO-220AC

PRODUCT SUMMARY				
V <sub>R</sub>	1200 V			
V <sub>F</sub> at 8 A at 25 °C	3.3 V			
I <sub>F(AV)</sub>	8 A			
t <sub>rr</sub> (typical)	28 ns			
T <sub>J</sub> (maximum)	150 °C			
Q <sub>rr</sub> (typical)	140 nC			
dl <sub>(rec)M</sub> /dt (typical) at 125 °C	85 A/µs			
I <sub>RRM</sub> (typical)	4.5 A			

# HFA08TB120PbF



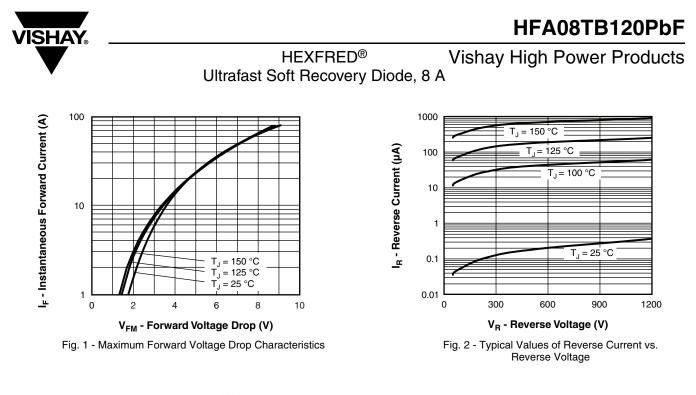
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<b>ELECTRICAL SPECIFICATIONS</b> ( $T_J = 25 \text{ °C}$ unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V <sub>BR</sub>	I <sub>R</sub> = 100 μA	1200	-	-	
Maximum forward voltage V <sub>FM</sub>	I <sub>F</sub> = 8.0 A	-	2.6	3.3	v	
	V <sub>FM</sub>	I <sub>F</sub> = 16 A	-	3.4	4.3	
		I <sub>F</sub> = 8.0 A, T <sub>J</sub> = 125 °C	-	2.4	3.1	
Maximum reverse I <sub>RM</sub>	$V_{R} = V_{R}$ rated	-	0.31	10		
	IRM	$T_J$ = 125 °C, $V_R$ = 0.8 x $V_R$ rated	-	135	1000	μΑ
Junction capacitance	CT	V <sub>R</sub> = 200 V	-	11	20	pF
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body - 8.0		8.0	-	nH

<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25$ °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
	t <sub>rr</sub>	$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	28	-	
Reverse recovery time	t <sub>rr1</sub>	T <sub>J</sub> = 25 °C	_	-	63	95	ns
	t <sub>rr2</sub>	T <sub>J</sub> = 125 °C		-	106	160	
Peak recovery currentIRRM1TJ = 25 °CIRRM2TJ = 125 °C	T <sub>J</sub> = 25 °C	]	-	4.5	8.0	А	
	I <sub>RRM2</sub>	T <sub>J</sub> = 125 °C	I <sub>F</sub> = 8.0 A dI <sub>F</sub> /dt = 200 A/μs V <sub>R</sub> = 200 V	-	6.2	11	~
Reverse recovery charge	Q <sub>rr1</sub>	T <sub>J</sub> = 25 °C		-	140	380	nC A/µs
	Q <sub>rr2</sub>	T <sub>J</sub> = 125 °C		-	335	880	
Peak rate of recovery current	dl <sub>(rec)M</sub> /dt1	T <sub>J</sub> = 25 °C		-	133	-	
during t <sub>b</sub>	dl <sub>(rec)M</sub> /dt2	T <sub>J</sub> = 125 °C		-	85	-	Αγμs

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS		TYP.	MAX.	UNITS
Lead temperature	T <sub>lead</sub>	0.063" from case (1.6 mm) for 10 s	-	-	300	°C
Thermal resistance, junction to case	R <sub>thJC</sub>		-	-	1.7	
Thermal resistance, junction to ambient	R <sub>thJA</sub>	Typical socket mount	-	-	40	K/W
Thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, flat, smooth and greased	-	0.25	-	
Weight			-	6.0	-	g
weight		-	0.21	-	oz.	
Mounting torque			6.0 (5.0)	-	12 (10)	kgf ⋅ cm (lbf ⋅ in)
Marking device		Case style TO-220AC	HFA08TB120			



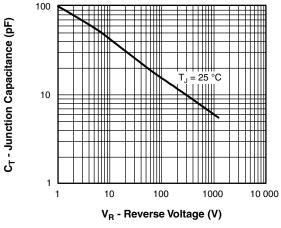


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

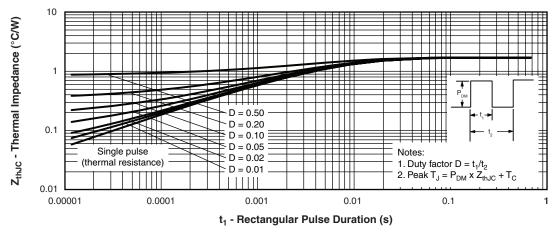


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

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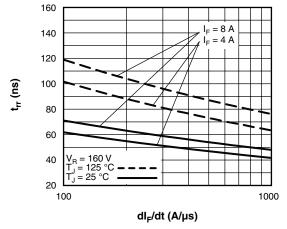


Fig. 5 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

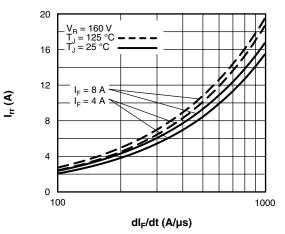


Fig. 6 - Typical Recovery Current vs. dI<sub>F</sub>/dt

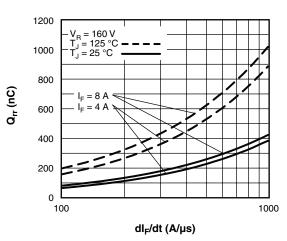


Fig. 7 - Typical Stored Charge vs. dI<sub>F</sub>/dt

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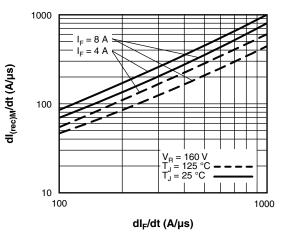


Fig. 8 - Typical  $dI_{(rec)M}/dt vs. dI_F/dt$ 



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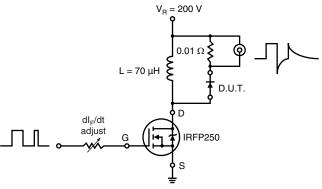


Fig. 9 - Reverse Recovery Parameter Test Circuit

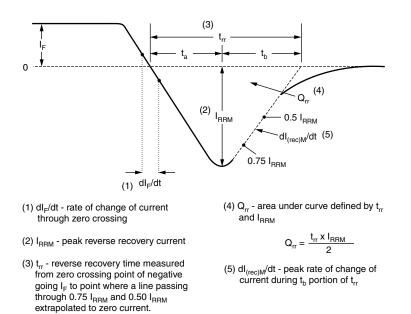


Fig. 10 - Reverse Recovery Waveform and Definitions

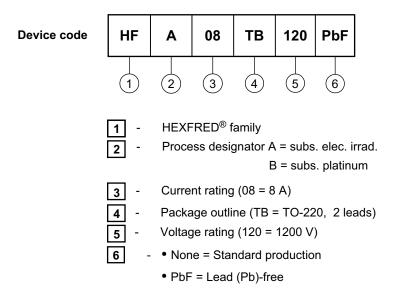
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### ORDERING INFORMATION TABLE



LINKS TO RELATED DOCUMENTS				
Dimensions http://www.vishay.com/doc?95221				
Part marking information http://www.vishay.com/doc?9522				



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